

SID

Factory: Rot am See

Article:

ML10

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm		Stackup	Process overview
A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	B00
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	185		2	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		3	
		35	L2		
C-RS-FR4-ML-0.107mm-035+035-TG150-HF-...	50203003	107		4	
		35	L3		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	124		5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		6	
		35	L4		
C-RS-FR4-ML-0.107mm-035+035-TG150-HF-...	50203003	107		7	
		35	L5		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	124		8	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		9	
		35	L6		
C-RS-FR4-ML-0.107mm-035+035-TG150-HF-...	50203003	107		10	
		35	L7		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	124		11	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		12	
		35	L8		
C-RS-FR4-ML-0.107mm-035+035-TG150-HF-...	50203003	107		13	
		35	L9		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	185		14	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		15	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	16	

Thickness after Pressing

B00:

1440 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1595 µm

Dmin:

1285 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1550 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1705 µm

Dmin:

1395 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

1486 µm

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